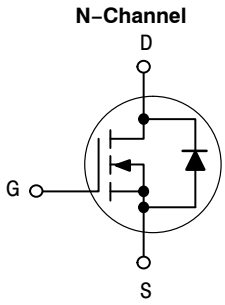
N-Channel Enhancement Mode Field Effect Transistor

2N7002L

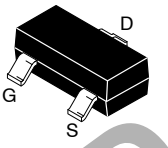


Description

This N−channel enhancement mode field effect transistor is produced using high cell density, trench MOSFET technology. This product minimizes on−state resistance while providing rugged, reliable and fast switching performance. This product is particularly suited for low−voltage, low−current applications such as small servo motor control, power MOSFET gate drivers, logic level translator, high speed line drivers, power management/power supply, and switching applications.

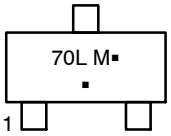
Features

- High Density Cell Design for Low $R_{DS(ON)}$
- Voltage Controlled Small Signal Switch
- Rugged and Reliable
- High Saturation Current Capability
- Very Low Capacitance
- Fast Switching Speed
- This Device is Pb−Free and Halogen Free



SOT−23
CASE 318−08

MARKING DIAGRAM



70L = Device Code
M = Date Code*
▪ = Pb−Free Package
(Note: Microdot may be in either location)
* Date Code orientation and/or position may vary depending upon manufacturing location.

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ORDERING INFORMATION

Device	Package	Shipping†
2N7002L	SOT−23 (Pb−Free)	3000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V_{DSS}	Drain−Source Voltage	60	V
V_{DGR}	Drain−Gate Voltage (R_{GS} ≤ 1.0 MΩ)	60	V
V_{GSS}	Gate−Source Voltage – Continuous – Non Repetitive (t_p < 50 μs)	 ±20 ±40	V
I_D	Maximum Drain Current – Continuous – Pulsed	 115 800	mA
T_J, T_{STG}	Operating and Storage Temperature Range	−55 to +150	°C
T_L	Maximum Lead Temperature for Soldering Purposes, 1/16″ from Case for 10 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Note 1)

Symbol	Parameter	Value	Unit
P_D	Maximum Power Dissipation	200	mW
	Derate Above 25°C	1.6	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction−to−Ambient	380	°C/W

ESD RATING (Note 2)

Symbol	Parameter	Value	Unit
HBM	Human Body Model per ANSI/ESDA/JEDEC JS−001−2012	50	V
CDM	Charged Device Model per JEDEC C101C	>2000	V

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain−Source Breakdown Voltage	V_{GS} = 0 V, I_D = 10 μA	60.0	65.2	–	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 60 V, V_{GS} = 0 V	–	0.024	1	μA
		V_{DS} = 60 V, V_{GS} = 0 V, T_J = 125°C	–	0.080	500	
I_{GSSF}	Gate−Body Leakage, Forward	V_{GS} = 20 V, V_{DS} = 0 V	–	0.107	100	nA
I_{GSSR}	Gate−Body Leakage, Reverse	V_{GS} = −20 V, V_{DS} = 0 V	–	−0.037	−100	nA
ON CHARACTERISTICS (Note 3)						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 μA	0.80	1.81	2.50	V
$R_{DS(on)}$	Static Drain−Source On−Resistance	V_{GS} = 10 V, I_D = 500 mA	–	3.35	7.50	Ω
		V_{GS} = 10 V, I_D = 500 mA, T_J = 100°C	–	5.62	13.50	
		V_{GS} = 5 V, I_D = 50 mA	–	2.68	7.50	
		V_{GS} = 5 V, I_D = 50 mA, T_J = 100°C	–	3.97	13.50	
$V_{DS(ON)}$	Drain−Source On−Voltage	V_{GS} = 10 V, I_D = 500 mA	–	1.68	3.75	V
		V_{GS} = 5 V, I_D = 50 mA	–	0.13	1.50	
$I_{D(ON)}$	On−State Drain Current	V_{GS} = 10 V, V_{DS} ≥ 2 $V_{DS(ON)}$	500	557	–	mA
		V_{GS} = 4.5 V, V_{DS} = 10 V	75	571	–	

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
ON CHARACTERISTICS (Note 3)						
g_{FS}	Forward Trans−conductance	$V_{DS} \geq 2\ V_{DS(ON)}$, I_D = 200 mA	80	214	–	mS
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	–	12.8	50	pF
C_{oss}	Output Capacitance		–	3.25	25	
C_{rss}	Reverse Transfer Capacitance		–	1.52	5	
R_G	Gate Resistance	V_{GS} = 0 V, f = 1.0 MHz	–	22.2	–	Ω
SWITCHING CHARACTERISTICS (Note 3)						
t_{on}	Turn−On Time	V_{DD} = 30 V, R_L = 150 Ω, I_D = 200 mA, V_{GS} = 10 V, R_{GEN} = 25 Ω	–	4.35	20	ns
t_{off}	Turn−Off Time		–	15.6	20	ns
Drain−Source Diode Characteristics and maximum ratings						
I_S	Maximum Continuous Drain−Source Diode Forward Current		–	–	115	mA
I_{SM}	Maximum Pulsed Drain−Source Diode Forward Current		–	–	0.8	A
V_{SD}	Drain−Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 115 mA (Note 3)		0.818	1.5	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $R_{\theta JA}$ is the sum of the junction−to−case and case−to−ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 380°C/W when mounted on a minimum pad.

2. ESD values are in typical, no over−voltage rating is implied, ESD CDM zap voltage is 2000 V maximum.
3. Pulse test: pulse width ≤ 300 μs, duty cycle ≤ 2.0%.

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TYPICAL CHARACTERISTICS

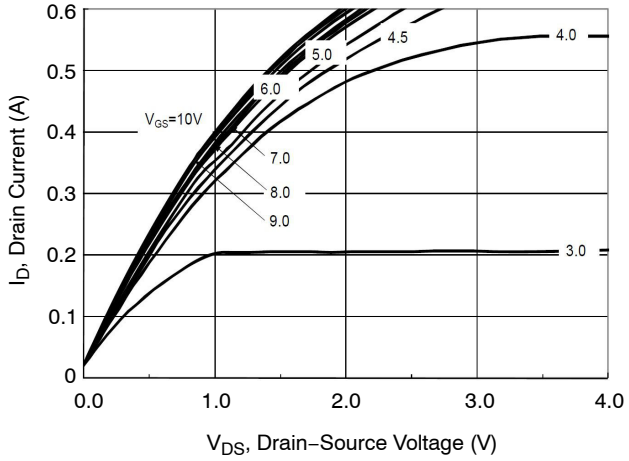


Figure 1. On−Region Characteristics

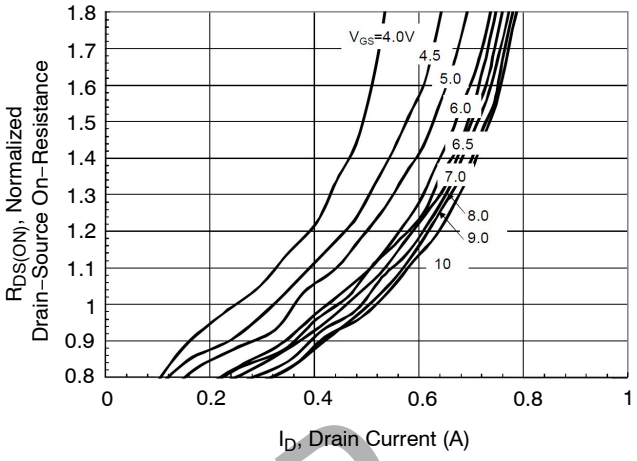


Figure 2. On−Resistance Variation with Gate Voltage and Drain Current

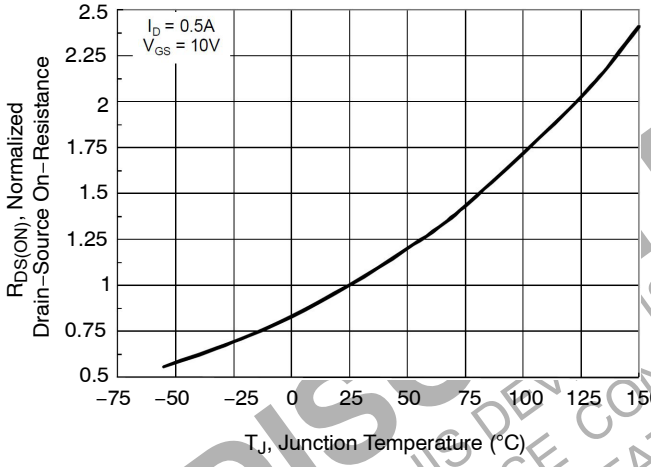


Figure 3. On−Resistance Variation with Temperature

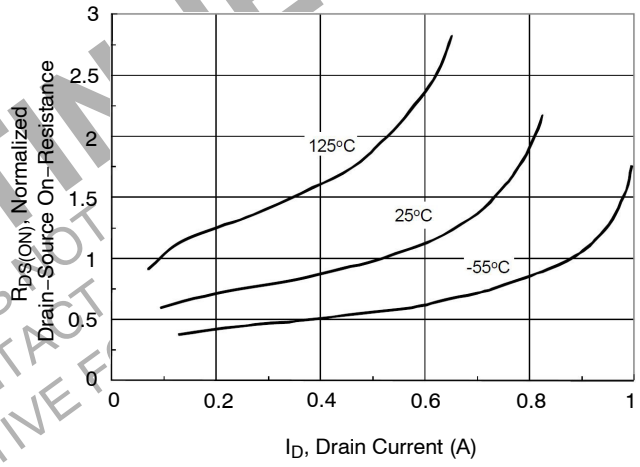


Figure 4. On−Resistance Variation with Drain Current and Temperature

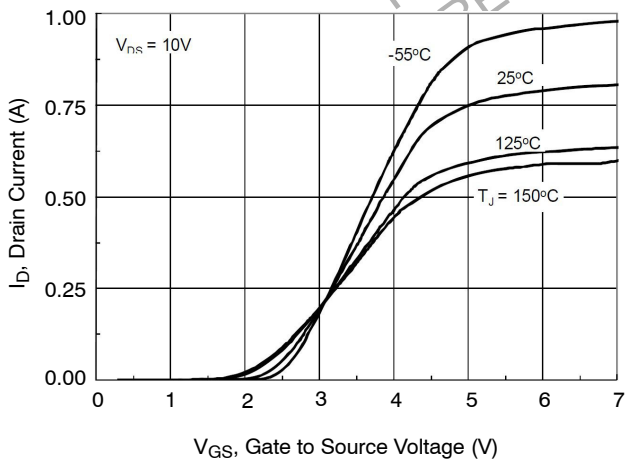


Figure 5. Transfer Characteristics

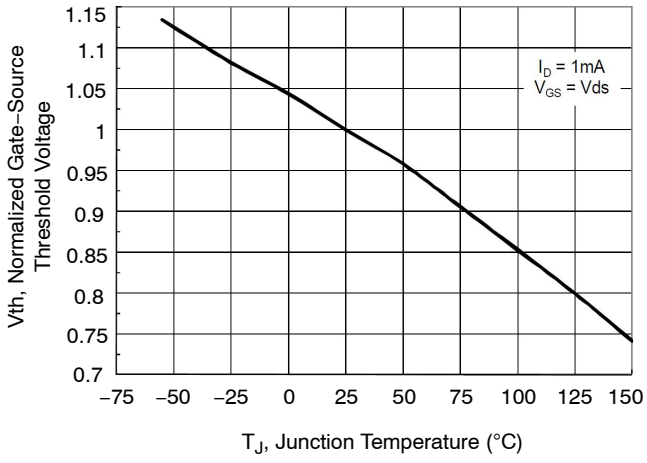


Figure 6. Gate Threshold Variation with Temperature

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TYPICAL CHARACTERISTICS (continued)

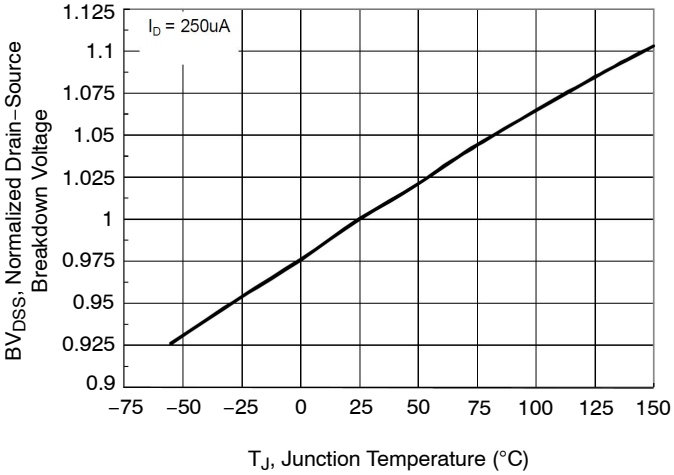


Figure 7. Breakdown Voltage Variation with Temperature

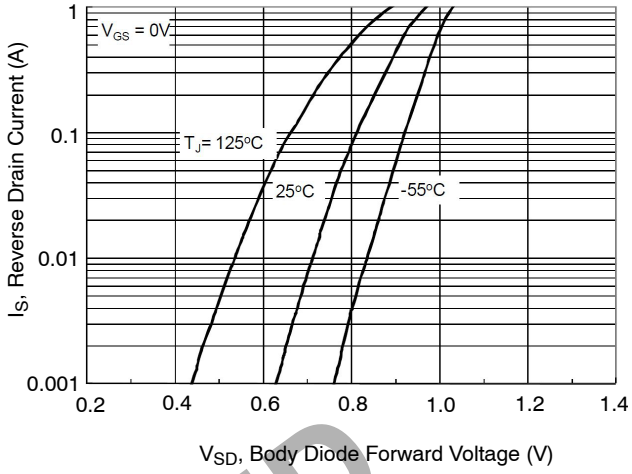


Figure 8. Body Diode Forward Voltage Variation with Source Current and Temperature

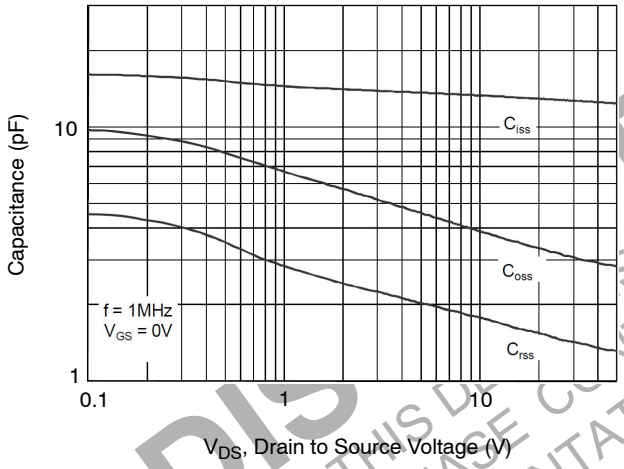


Figure 9. Capacitance Characteristics

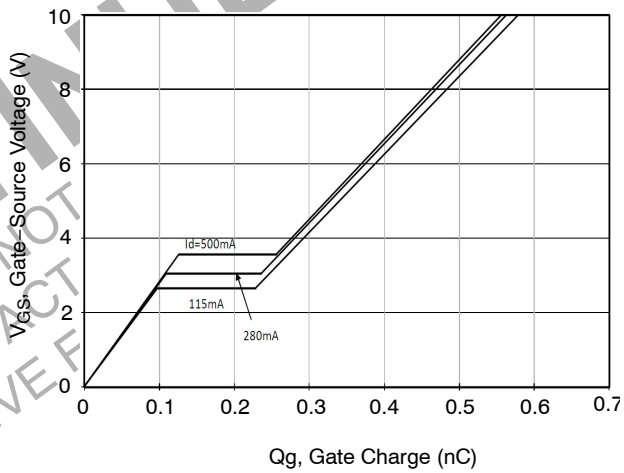


Figure 10. Gate Charge Characteristics

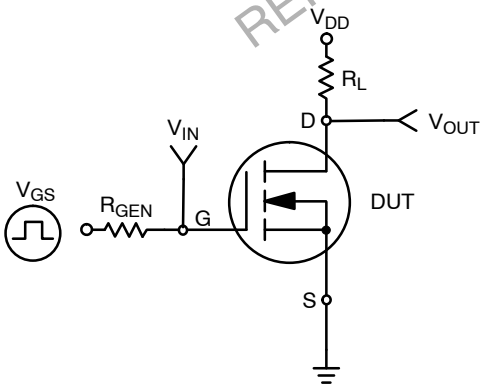


Figure 11.

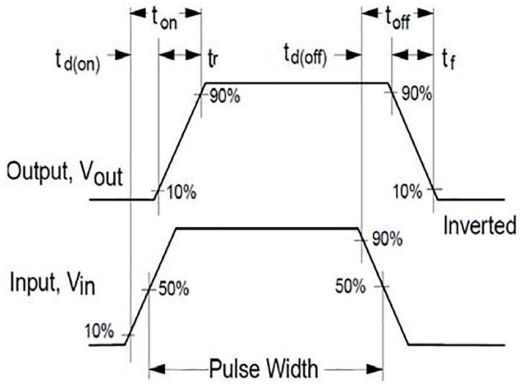


Figure 12. Switching Waveforms

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TYPICAL CHARACTERISTICS (continued)

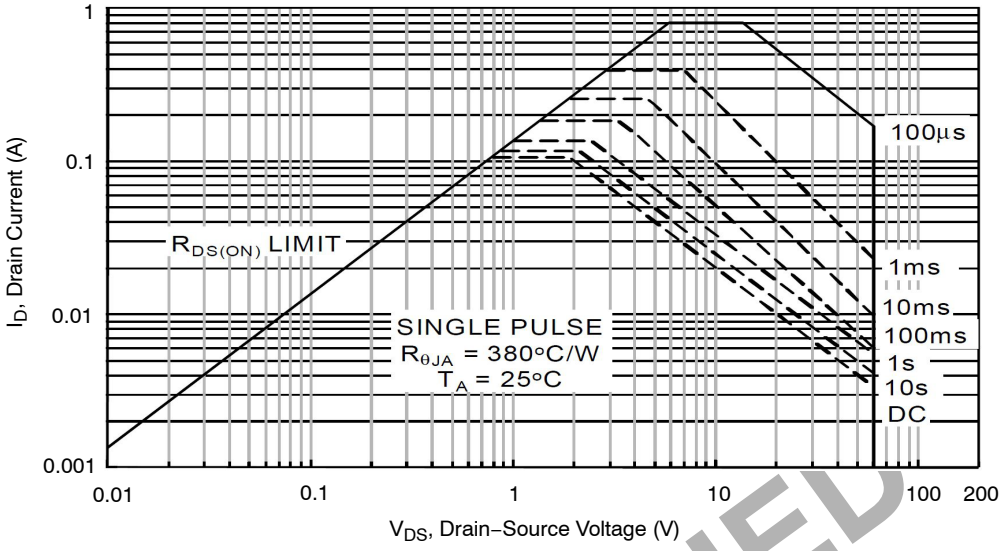


Figure 13. Maximum Safe Operating Area

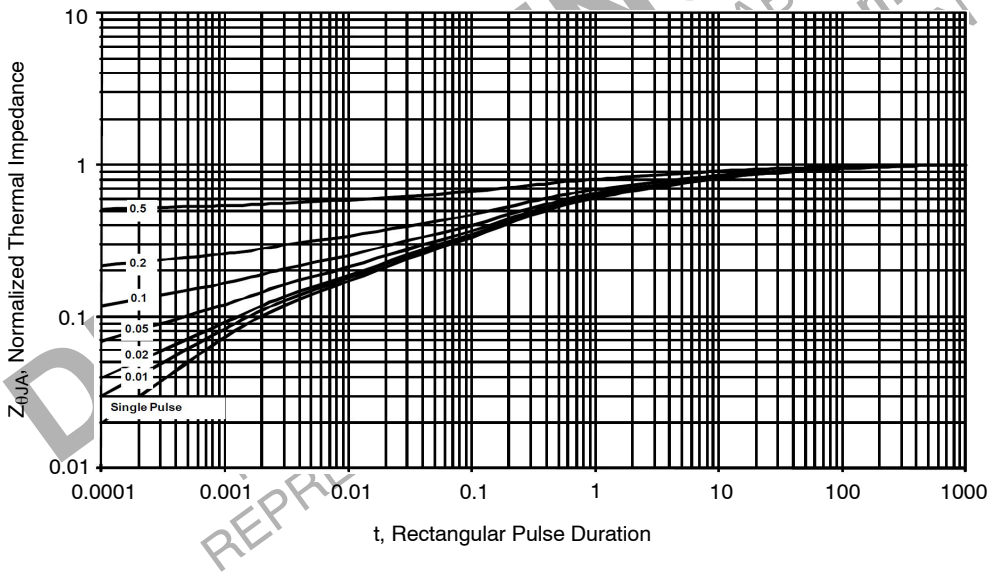


Figure 14. Transient Thermal Response Curve

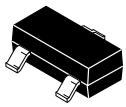
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REVISION HISTORY

Revision	Description of Changes	Date
3	Document Discontinued.	1/13/2026

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

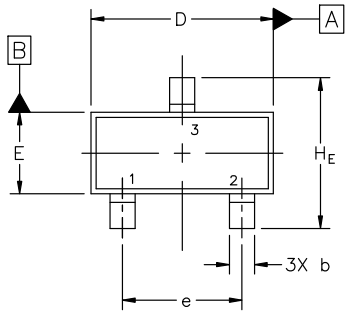
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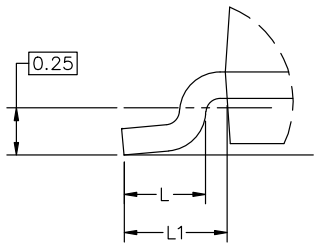
SCALE 4:1

SOT−23 (TO−236) 2.90x1.30x1.00 1.90P
CASE 318
ISSUE AU

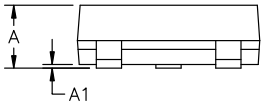
DATE 14 AUG 2024



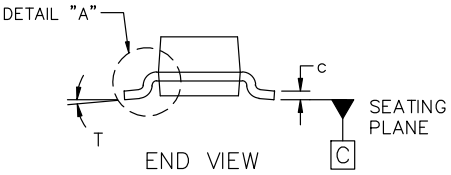
TOP VIEW



DETAIL "A"
Scale 3:1



SIDE VIEW

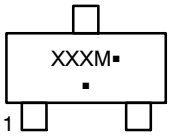


END VIEW

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.89	1.00	1.11
A1	0.01	0.06	0.10
b	0.37	0.44	0.50
c	0.08	0.14	0.20
D	2.80	2.90	3.04
E	1.20	1.30	1.40
e	1.78	1.90	2.04
L	0.30	0.43	0.55
L1	0.35	0.54	0.69
H_E	2.10	2.40	2.64
T	0°	−−−	10°

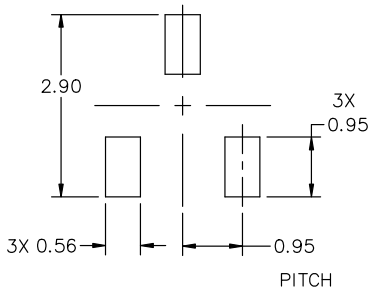
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSIONS: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

GENERIC
MARKING DIAGRAM*



XXX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.



RECOMMENDED
MOUNTING FOOTPRINT

* For additional information on our Pb−Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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DESCRIPTION:	**SOT−23 (TO−236) 2.90x1.30x1.00 1.90P**		**PAGE 1 OF 2**

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CASE 318
ISSUE AU

DATE 14 AUG 2024

STYLE 1 THRU 5:
CANCELLED

STYLE 6:
PIN 1. BASE
2. EMITTER
3. COLLECTOR

STYLE 7:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

STYLE 8:
PIN 1. ANODE
2. NO CONNECTION
3. CATHODE

STYLE 9:
PIN 1. ANODE
2. ANODE
3. CATHODE

STYLE 10:
PIN 1. DRAIN
2. SOURCE
3. GATE

STYLE 11:
PIN 1. ANODE
2. CATHODE
3. CATHODE−ANODE

STYLE 12:
PIN 1. CATHODE
2. CATHODE
3. ANODE

STYLE 13:
PIN 1. SOURCE
2. DRAIN
3. GATE

STYLE 14:
PIN 1. CATHODE
2. GATE
3. ANODE

STYLE 15:
PIN 1. GATE
2. CATHODE
3. ANODE

STYLE 16:
PIN 1. ANODE
2. CATHODE
3. CATHODE

STYLE 17:
PIN 1. NO CONNECTION
2. ANODE
3. CATHODE

STYLE 18:
PIN 1. NO CONNECTION
2. CATHODE
3. ANODE

STYLE 19:
PIN 1. CATHODE
2. ANODE
3. CATHODE−ANODE

STYLE 20:
PIN 1. CATHODE
2. ANODE
3. GATE

STYLE 21:
PIN 1. GATE
2. SOURCE
3. DRAIN

STYLE 22:
PIN 1. RETURN
2. OUTPUT
3. INPUT

STYLE 23:
PIN 1. ANODE
2. ANODE
3. CATHODE

STYLE 24:
PIN 1. GATE
2. DRAIN
3. SOURCE

STYLE 25:
PIN 1. ANODE
2. CATHODE
3. GATE

STYLE 26:
PIN 1. CATHODE
2. ANODE
3. NO CONNECTION

STYLE 27:
PIN 1. CATHODE
2. CATHODE
3. CATHODE

STYLE 28:
PIN 1. ANODE
2. ANODE
3. ANODE

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Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

www.entegreci.com | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

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